

1.0A Surface Mount Ultra Fast Rectifiers -600V

Features

- Ideal for surface mounted application
- Low profile surface mounted application in order to optimize board space
- Bulit-in strain relief design
- Ultra fast recovery time for high efficient
- Glass passivated chip junction
- Lead-free parts meet RoHS requirements
- Compliant to Halogen-free

Mechanical data

• Epoxy:UL94-V0 rated flame retardant

• Case: Molded plastic, SMA(DO-214AC)

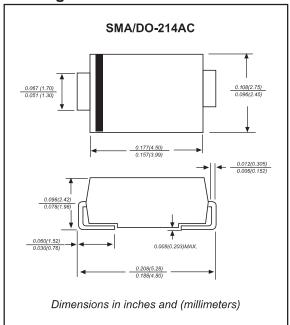
• Terminals : Solder plated, solderable per

MIL-STD-750, Method 2026

• Polarity : Indicated by cathode band

• Mounting Position : Any

Package outline



Maximum ratings (AT T_A=25°C unless otherwise noted)

PARAMETER	SYMBOLS	MURA160T3G	UNITS
Maximum repetitive peak reverse voltage	VRRM	600	V
Maximum RMS voltage	VRMS	420	V
Maximum continuous reverse voltage	VR	600	V
Maximum average forward rectified current	lo	1.0	А
Non-repetitive peak forward surge current 8.3ms single half sine-wave	IFSM	35	А
Typical junction capacitance (Note 1)	CJ	15	pF
Operating junction temperature range	TJ	-55 to +175	°C
Storage temperature range	Тѕтс	-65 to +175	°C

Electrical characteristics (AT T_A=25°C unless otherwise noted)

PARAMETER	SYMBOLS	MURA160T3G	UNITS
Maximum instantaneous forward voltage at IF=1.0A T _J =25 °C	VF	1.25	V
Maximum instantaneous forward voltage at IF=1.0A TJ=150°C	VF	1.05	V
Maximum reverse leakage current T _J =25 °C at rated V _R T _J =125 °C	lr	5.0 150	μA
Maximum reverse recovery time, (Note 2)	trr	50	ns

Thermal characteristics

PARAMETER	SYMBOLS	MURA160T3G	UNITS
Typical thermal resistance junction to ambient , (Note 3) Typical thermal resistance junction to case , (Note 3)	Rеја Rејс	25 15	°C/W

Notes 1: Measured at 1 MHz and applied reverse voltage of 4.0 VDC

2: Measured with IF = 0.5 A, IR = 1 A, Irr = 0.25 A

^{3:} Mounted on FR-4 PCB Copper, minimum recommended pad layout

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Rating and characteristic curves

FIG.1-TYPICAL FORWARD **CHARACTERISTICS** INSTANTANEOUS FORWARD CURRENT,(A) 10 1 0.1 0.01 0.001 0.2 0.4 0.6 0.8 1.2 1.4 1,6 1.8 FORWARD VOLTAGE,(V)

FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE

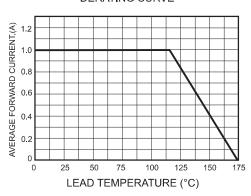


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

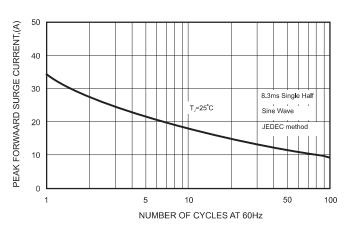
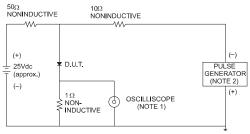


FIG.3- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm.22pF.

2. Rise Time= 10ns max., Source Impedance= 50 ohms.

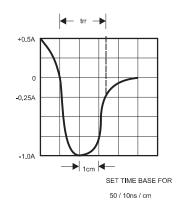
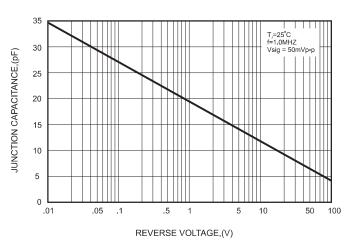


FIG.5-TYPICAL JUNCTION CAPACITANCE





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Pinning information

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode	1 2	1 2

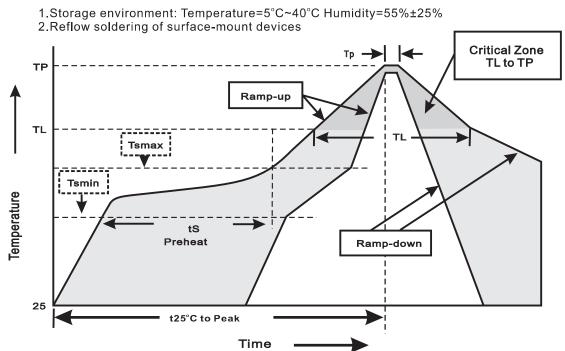
Marking

Type number	Marking code
MURA160T3G	HL6



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Suggested thermal profiles for soldering processes



3.Reflow soldering

Profile Feature	Soldering Condition
Average ramp-up rate(T∟ to T _P)	<3°C/sec
Preheat -Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(min to max)(ts)	150°C 200°C 60~120sec
Tsmax to T∟ -Ramp-upRate	<3°C/sec
Time maintained above: -Temperature(T∟) -Time(t∟)	217°C 60~260sec
Peak Temperature(T _P)	255°C-0/+5°C
Time within 5°C of actual Peak Temperature(t _P)	10~30sec
Ramp-down Rate	<6°C/sec
Time 25°C to Peak Temperature	<6minutes